

PRODUCT : LCD MODULE
MODEL NO : LCD240DLBH-01-100N
SUPPLIER : **LCD Mikroelektronik GmbH**
DATE : Aug.08.2018

SPECIFICATION

Prepared by	Checked	Approved

CUSTOMER:
MODEL NO.:

DATE:

Approved	Checked	Department

ADD: Otto-Lilienthal-Str. 13, D-76275 Ettlingen

E-mail : lcd@lcd-mikroelektronik.de

Web: <http://www.lcd-mikroelektronik.com>

CONTENTS

1. General Specifications	4
2. Mechanical Drawing	5
3. PIN Assignment	6
4. Absolute Maximum Rating	7
5. Electrical Characteristics.....	7
5.1. Recommended Operating Condition.....	7
5.2. Rcommended Driving Condition for Backlight.....	7
6. Timing Characteristics	8
6.1. AC Electrical Characteristics	8
6.2. DC Electrical Characteristics	9
6.3. Timing	10
6.4. Power on/off sequence	13
7. Optical Characteristics	15
8. Environmental/Reliability Test.....	18
9. Packing Drawing.....	19
10. Standard Specifications For Product Quality.....	20
11. Precautions for Use of LCD Modules.....	24
12. Prior Consult Matter.....	28
13. Factory.....	28

Revision Record

Rev No.	Rev Date	Contents	Remarks
1.0	2016.10.20	New creation	
1.1	2016.11.30	Add(Rx,Ry), (Bx,By), (Gx,Gy)	P12
1.2	2017.02.28	Optimize viewing angles	P12
1.3	2018.03.16	Modify temperature.	P5
1.4	2018.08.08	Modify mechanical drawing and temperature.	P5

1. General Specifications

No	Item	Contents	Unit
1	Size	2.4 (Diagonal)	inch
2	Resolution	240(RGB)*320	
3	Interface	Parallel	
4	Color Depth	262K	
5	Technology Type	a-Si TFT	
6	Pixel size	153*153	um
7	Pixel Arrangement	RGB vertical stripe	
8	Display Mode	Transmissive	
9	Viewing Direction	6:00	
10	LCM (W x H x D)	42.72*60.26*2.45	mm
11	Active Area (W x H)	36.72*48.96	mm
12	With/Without TSP	Without TSP	
13	LED Numbers	4	

2. Mechanical Drawing

CUSTOMER'S APPROVED:	DATE:	PAGE:		
-----------------------------	--------------	--------------	--	--

Top view dimensions: 60.26±0.15, 56.46±0.1, 48.96±0, 42.72±0.15, 40.52±0.1, 36.72±0, 1.1, 1.25, 2.6, 1.1, 3, 17.4±0.5, 3.22, 1.6±0.3, 1.9, 0.6±0.05, 1.0X(39-1)=38±0.1, 39, *41, 0.86±0.5, 1, 1.9±0.3, 40.64, 1.04, 2.69, 3.08, 7.18, 8.6, 5, 1.46, 37.5, 34.76, 8, 0.75, 1.04, 3-Ø1±0.1, 1.1Min, 3-0.6, *2.45MAX, 0.6±0.1, 0.13±0.05

Side view dimensions: 58.76, 0.6±0.1, 0.13±0.05, 1.1Min, 3-0.6, *2.45MAX

Cross-section dimensions: 0.75, 1.04, 3-Ø1±0.1, 58.76, 37.5, 34.76, 8, 1.46, 1.82, 7.18, 3.08, 8.6, 5, 1.46, 2.69, 1.04, 1.9±0.3, 40.64

LED Internal circuit diagram:

PIN(A) → PIN(K1)
 PIN(A) → PIN(K2)
 PIN(A) → PIN(K3)
 PIN(A) → PIN(K4)

If = 60 mA
Forward Voltage: 3.1V (typ)

1	Operating Voltage:	Vcc=3.0V typ.
2	Resolution:	240RGB*320
3	Color:	262K
4	Interface:	Parallel
5	Display type:	Transmissive, TN
6	Viewing Direction:	6:00
7	Operating Temp:	-30°C~80°C
8	Storage Temp:	-30°C~85°C
9	Driver IC:	ST7789V
10	Surface Luminance:	220cd/m2(typ.)
11	Unspecified tolerance:	±0.2

NO.	DESCRIPTION	DATE
①	Modify the current voltage of backlight	解明亮 2017. 02. 21
②	Modify the side of A.A	解明亮 2018. 02. 09
③		
④		

Unit: mm

Chk
Apr

--	--	--	--	--

1	GND
2	LEDA
3	LEDK4
4	LEDK3
5	LEDK2
6	LEDK1
7	CND
8	NC
9	IM0
10	RRESET
11	D15
12	D14
13	D13
14	D12
15	D11
16	D10
17	D9
18	D8
19	D7
20	D6
21	D5
22	D4
23	D3
24	D2
25	D1
26	D0
27	/RD
28	/WR
29	/RS
30	/CS
31	NC
32	VDDI
33	VCI
34	NC
35	NC
36	NC
37	NC
38	NC
39	GND

3. PIN Assignment

Pin No	Symbol	I/	Function	Remark
1	GND	P	Ground	
2	LEDA	P	LED backlight anode.	
3-6	,LEDK4 LEDK3,LEDK2 LEDK1	P	LED backlight cathode.	
7	GND	P	Ground	
8	NC	-	No connected	
9	IM0	I	Parallel 8-bit and 16-bit select	
10	Reset	I	Reset signal	
11~26	D15~D0	I	Data bus	
27	/RD	I	Read signal	
28	/WR	I	Write signal	
29	RS	I	Select data or command	
30	/CS	I	Chip select input pin	
31	NC	-	No connected	
32	VDDI	P	Low voltage power supply for interface logic circuits	
33	VCI	P	High voltage power supply for analog circuit blocks	
34~38	NC	-	No connected	
39	GND	P	Ground	

PS: For further details, please refer to ST7789V data sheet.

4. Absolute Maximum Rating

AGND = GND = 0V , Ta = 25° C

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VCI	-0.3	4.6	V	
	VDDI	-0.3	4.6	V	
Backlight Forward Current	I _{LED}	-	30	mA	For each LED
Operating Temperature	T _{OPR}	-30	80	° C	
Storage Temperature	T _{STG}	-30	85	° C	

Note: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5. Electrical Characteristics

5.1. Recommended Operating Condition

AGND = GND = 0V , Ta = 25° C

Item	Symbol	Min	Typ.	Max	Unit	Remark
Power Voltage	VCI	2.5	3.0	3.3	V	
	VDDI	1.65	1.8	3.3		
Input logic high voltage	V _{IH}	0.7 VDDI	-	VDDI	V	
Input logic low voltage	V _{IL}	VSS	-	0.3VDDI	V	

5.2. Recommended Driving Condition for Backlight

Ta = 25° C

Item	Symbol	Min	Typ.	Max	Unit	Remark
Forward Voltage	V _f		3.1		V	
Forward Current	I _f		60		mA	
Operating Life Time	-	20000			Hours	

Note 1: The LED supply voltage is defined by the number of LED at Ta=25°C and I_f=60mA.

Note 2: The “Operating Life Time” is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_f = 60 mA. The LED lifetime could be decreased if operating I_f is larger than 60 mA.

6. Timing Characteristics

6.1. AC Electrical Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 °C

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T _{AST}	Address setup time	0		ns	-
	T _{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T _{CHW}	Chip select "H" pulse width	0		ns	-
	T _{CS}	Chip select setup time (Write)	15		ns	
	T _{RCS}	Chip select setup time (Read ID)	45		ns	
	T _{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T _{CSF}	Chip select wait time (Write/Read)	10		ns	
	T _{CSH}	Chip select hold time	10		ns	
WRX	T _{WC}	Write cycle	66		ns	
	T _{WRH}	Control pulse "H" duration	15		ns	
	T _{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T _{RC}	Read cycle (ID)	160		ns	When read ID data
	T _{RDH}	Control pulse "H" duration (ID)	90		ns	
	T _{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T _{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T _{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T _{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T _{DST}	Data setup time	10		ns	For CL=30pF
	T _{DHT}	Data hold time	10		ns	
	T _{RAT}	Read access time (ID)		40	ns	
	T _{RATFM}	Read access time (FM)		340	ns	
	T _{ODH}	Output disable time	20	80	ns	

8080 Parallel Interface Characteristics

6.2. DC Electrical Characteristics

Parameter	Symbol	Condition	Specification			Unit	Related Pins
			MIN.	TYP.	MAX.		
Power & Operation Voltage							
System Voltage	VDD	Operating voltage	2.4	2.75	3.3	V	
Interface Operation Voltage	VDDI	I/O Supply Voltage	1.65	1.8	3.3	V	
Gate Driver High Voltage	VGH		12.2		14.97	V	Note 4
Gate Driver Low Voltage	VGL		-12.5		-7.16	V	
Gate Driver Supply Voltage		VGH-VGL	19.36		27.47	V	Note 5
Input / Output							
Logic-High Input Voltage	VIH		0.7VDDI		VDDI	V	Note 1
Logic-Low Input Voltage	VIL		VSS		0.3VDDI	V	Note 1
Logic-High Output Voltage	VOH	IOH = -1.0mA	0.8VDDI		VDDI	V	Note 1
Logic-Low Output Voltage	VOL	IOL = +1.0mA	VSS		0.2VDDI	V	Note 1
Logic-High Input Current	IIH	VIN = VDDI			1	uA	Note 1
Logic-Low Input Current	IIL	VIN = VSS	-1			uA	Note 1
Input Leakage Current	IIL	IOH = -1.0mA	-0.1		+0.1	uA	Note 1
VCOM Voltage							
VCOM amplitude	VCOM			VSS		V	
Source Driver							
Source Output Range	Vsout		VAN		VAP	V	
Gamma Reference Voltage(Positive)	VAP		4.45		6.4	V	Note 6
Gamma Reference Voltage(Negative)	VAN		-4.6		-2.65	V	
Source Output Settling Time	Tr	Below with 99% precision			20	us	Note 2
Output Offset Voltage	VOFFSET				35	mV	Note 3

Table 2 Basic DC Characteristics

Notes:

1. TA= -30 to 70°C (to +85°C no damage).
2. Source channel loading= 2KΩ+12pF/channel, Gate channel loading=5KΩ+40pF/channel.
3. The Max. value is between measured point of source output and gamma setting value.
4. When evaluating the maximum and minimum of VGH, VDD=2.8V.
5. The maximum value of |VGH-VGL| can no over 30V.
6. Default register setting of Vcom and Vcomoffset is 20h

6.3. Timing

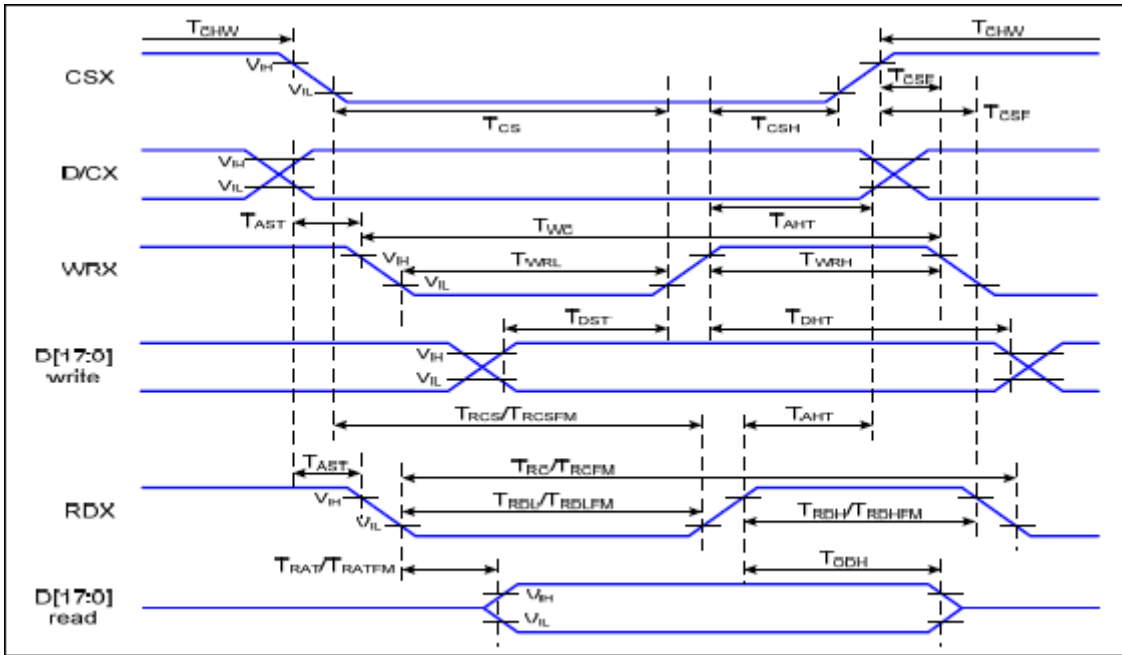


Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

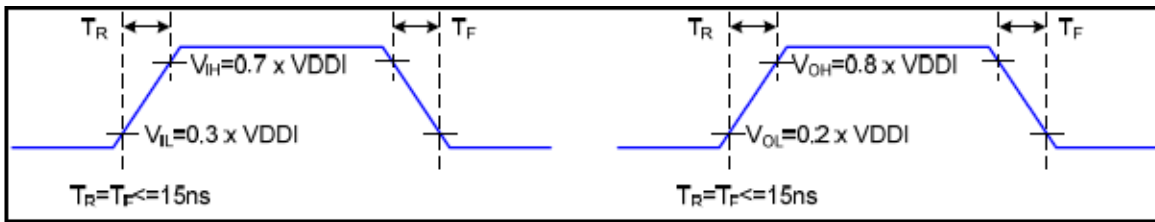


Figure 2 Rising and Falling Timing for I/O Signal

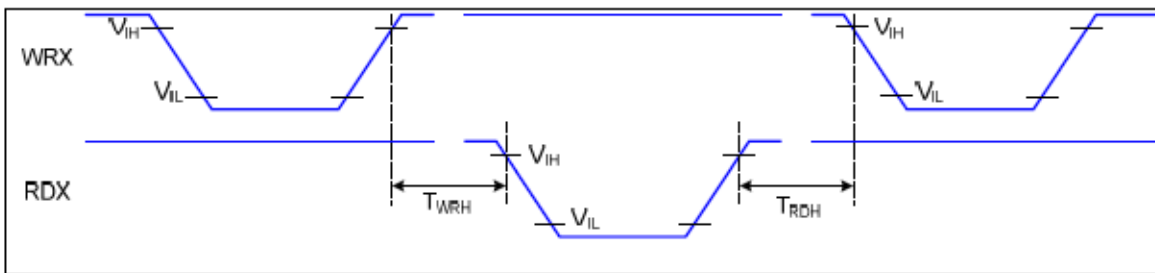


Figure 3 Write-to-Read and Read-to-Write Timing

Note: The rising time and falling time (T_r , T_f) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

6.4. Power on/off sequence

VDDI and VDD can be applied in any order.

VDD and VDDI can be power down in any order.

During power off, if LCD is in the Sleep Out mode, VDD and VDDI must be powered down minimum 120msec after RESX has been released.

During power off, if LCD is in the Sleep In mode, VDDI or VDD can be powered down minimum 0msec after RESX has been released.

CSX can be applied at any timing or can be permanently grounded. RESX has priority over CSX.

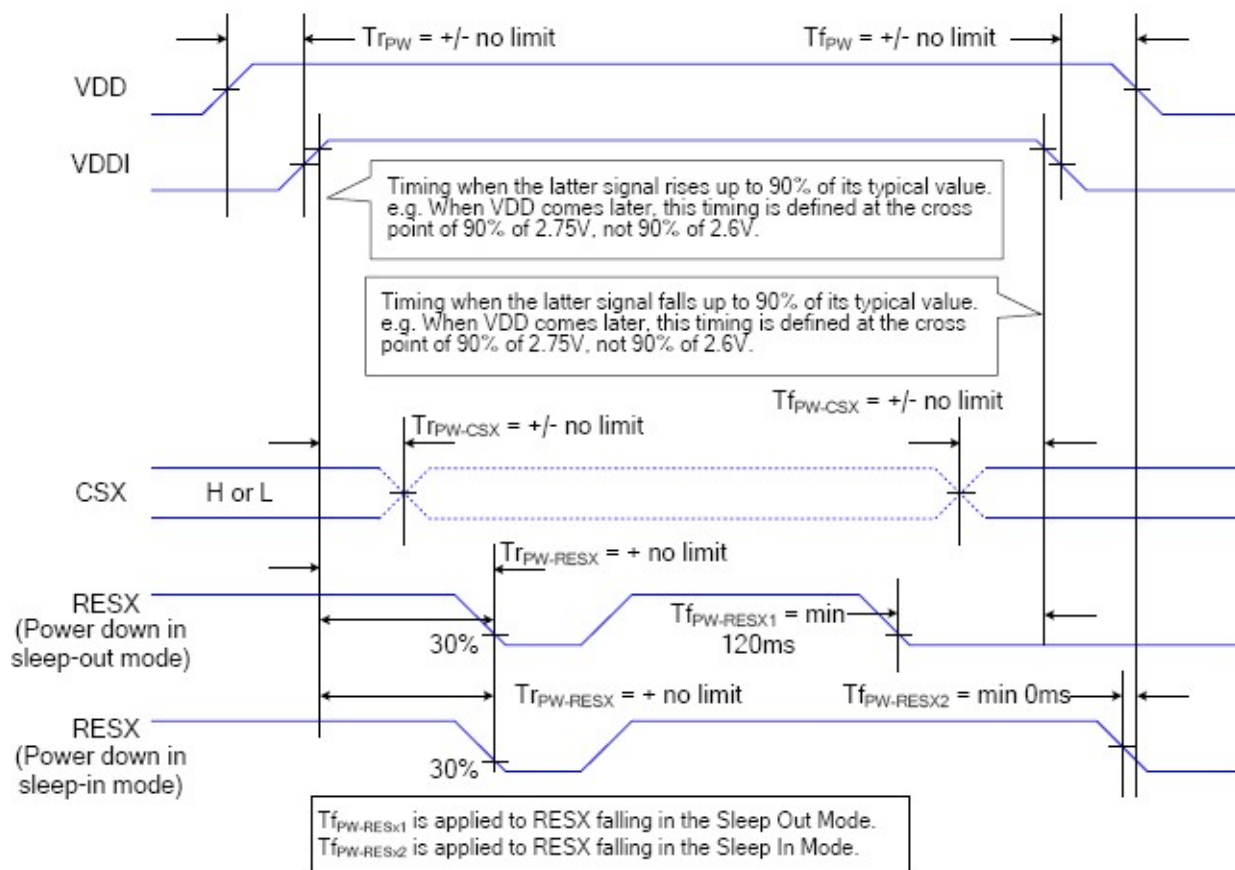
Note 1: There will be no damage to the display module if the power sequences are not met.

Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.

Note 3: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.

Note 4: If RESX line is not held stable by host during Power On Sequence as defined in the sequence below, then it will be necessary to apply a Hardware Reset (RESX) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.

The power on/off sequence is illustrated below



7. Optical Characteristics

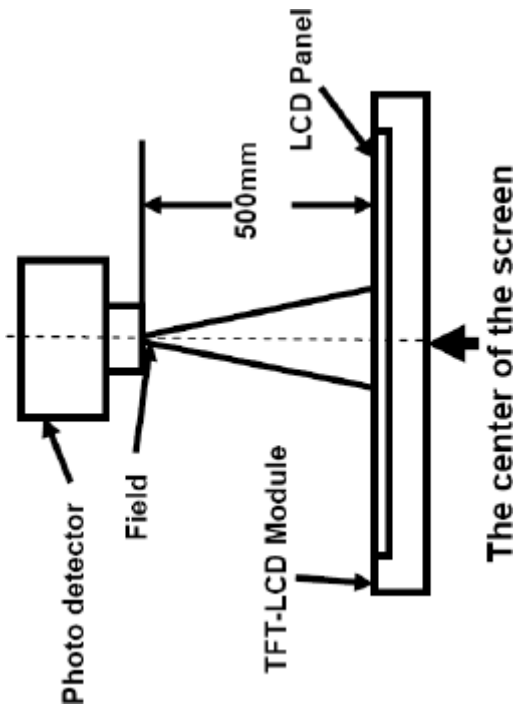
Item	Symbol	Condition	Min	Typ.	Max	Unit	Remark
View Angles	θ L	$CR \geq 10$		60	-	Degree	Note 2
	θ R			60	-		
	θ T			60	-		
	θ B			45	-		
Contrast Time	CR	$\theta = 0^\circ$		250	-	-	Note 1 Note 3
Response Time	$T_{ON}+T_{OFF}$	25° C	-	30	-	ms	Note 1 Note 4
Chromaticity	W_x	x		0.308			Note 1 Note 5
	W_y	y		0.325			
	R_x	x		0.612			
	R_y	y		0.329			
	G_x	x		0.299			
	G_y	y		0.567			
	B_y	x		0.144			
	B_y	y		0.110			
Luminance	L			220	-	cd/m ²	Note 1 Note 5

Test Conditions:

- $I_{LED} = 60\text{mA}$ (Backlight current), $V_{CI} = 3.0$ V, the ambient temperature is 25° C.
- The test systems refer to Note 2.

Note1: Definition of optical measurement system.

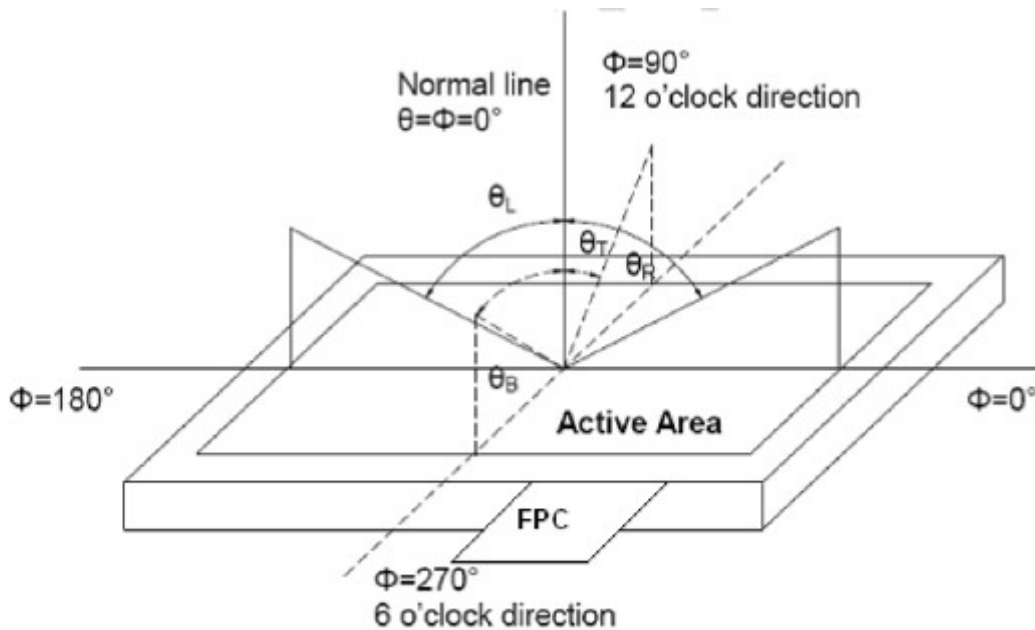
The optical characteristics should be measured in dark room. After 5Minutes operation, the optical properties are measured at the center point of the LCD screen. ALL input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field
Contrast Ratio	CS1000	1°
Luminance		
Lum Uniformity		
Chromaticity	CS1000	
Response Time	DMS703	-

Note2: Definition of viewing angle range and measurement system.

Viewing angle is measured at the center point of the LCD by CONOSCOPE (DMS703)



Note3: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$$

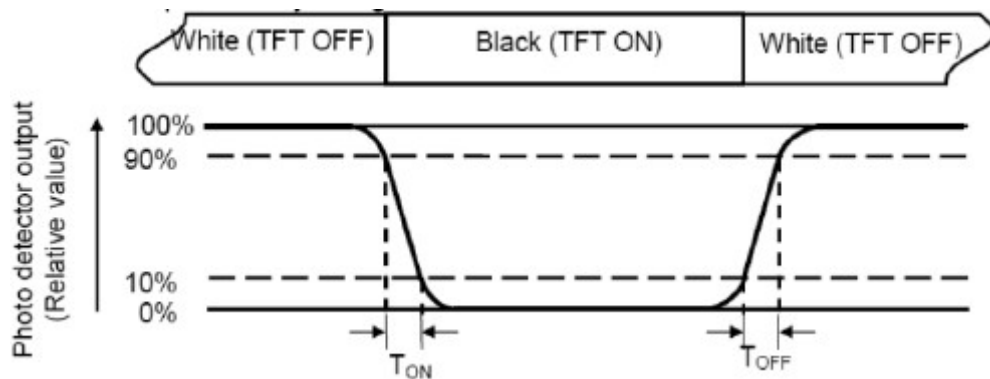
“White state ”:The state is that the LCD should drive by V_{white} .

“Black state ”:The state is that the LCD should drive by V_{black} .

V_{white} : To be determined V_{black} : To be determined

Note4:Definition of Response time

The response time is defined as the LCD optical switching time interval between “White”state and “Black” state. Rise time (T_{ON})is the time between photo detector output intensity changed from 90% to 10%.And fall time (T_{OFF})is the time between photo detector output intensity changed from 10% to90%.



Note5:Definition of color chromaticity (CIE1931)

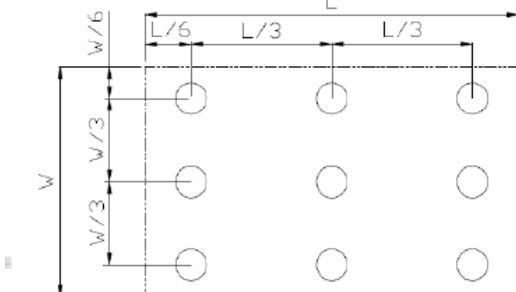
Color coordinates measured at center point of LCD.

Note6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas(Refer Fig.2).Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (U)} = L_{\text{min}}/L_{\text{max}}$$

L-----Active area length W -----Active area width



L_{max} : The measured Maximum luminance of all measurement position.

L_{min} : The measured Minimum luminance of all measurement position.

Note7: Definition of luminance: Measure the luminance of white state at center point.

8. Environmental/Reliability Test

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	85±2 °C/240 hours	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Sealleak; 3.Non-display; 4.missing segments; 5.Glass crack; 6.Current Idd is twice higher than initial value.
2	Low Temperature Storage	-30±2 °C/240 hours	
3	High Temperature Operating	80±2 °C/240 hours	
4	Low Temperature Operating	-30±2 °C/240 hours	
5	Temperature Cycle	-30 °C~25~85 °C ×20cycles (30min.) (30min.)	
6	Damp Proof Test	40 °C±5 °C×90%RH/240 hours	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	
9	ESD test	Contact Voltage:±4Kv,5times R: 330Ω C: 150pF Air discharge, ±8Kv,5times	

Remark:

1. The test samples should be applied to only one test item.
2. Sample size for each test item is 5~10pcs.
- 3.For Damp Proof Test, Pure water(Resistance>10MΩ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.
- 6.Please use automatic switch menu(or roll menu) testing mode when test operating mode.

9. Packing Drawing

CUSTOMER'S APPROVED:

DATE: 2017.07.18

PAGE: 1/1

PRODUCT PART NO.: 240DLBH-01-100N

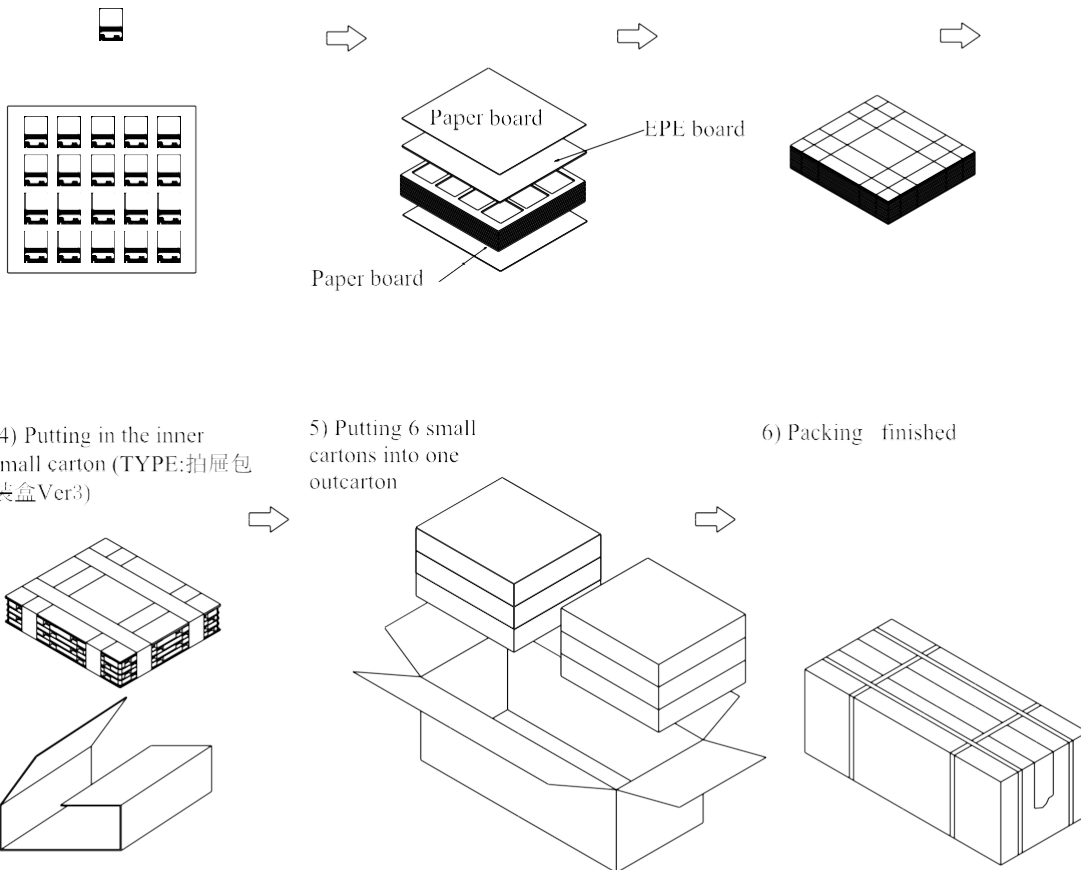
PACKING TYPE: BY EPE TRAY(T240DLBH-01-100A)

PACKLING ORDER:

1) Putting 20 pcs Modules on each EPE tray.

2) Putting 9 pcs EPE trays together with EPE paper on the top of EPE tray.

3) Assembling the boards and the tray together with adhesive tape



Note: 20 pcs in a tray, 9 trays in a inner carton, 6 inner cartons in a out carton, so $20 \times 9 \times 6 = 1080$ pcs/Outcarton

Dimension (Small carton): 364*324*82mm

Dimension (Out carton): 375*665*265mm

10. Standard Specifications For Product Quality

10.1. Manner of test:

10.1.1 The test must be under 40W fluorescent light, and the distance of view must be at 30±10cm.

10.1.2 Room temperature 25±5 °C Humidity: (60±10) %RH.

10.2. Quality specification

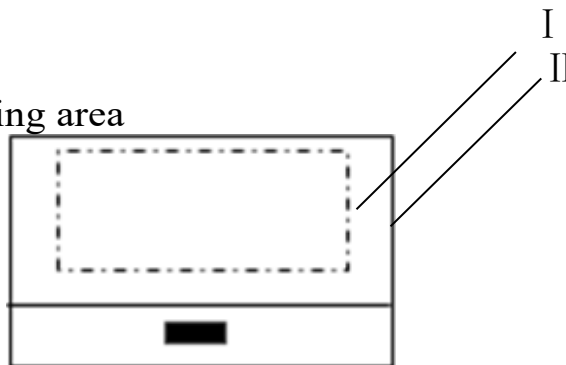
It shall be based on GB2828-87, inspection level II .

	IETM	CHECK LEVEL	AQL
MAJOR (MA)	1.Liquid crystal leakage 2.Wrong polarizer 3.Outside dimension 4. Bright dot、 Dark dot 5. Display abnormal 6. Class crack	II	0.25
MINOR (MI)	1. Spot Defect (Including black spot、 white spot、 pinhole、 foreign particle、 bubbles、 hurt) 2. fragment 3. Line Defect (Including black line、 white line、 cratch) 4. Incision defect 5. Newton's ring 6. Other visual defects	II	1.0

10.3. Definition of area:

10.3.1 I area: viewing area


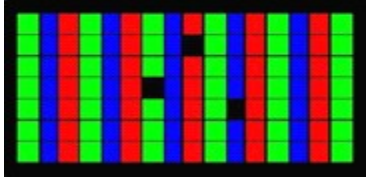
'' area: outside viewing area



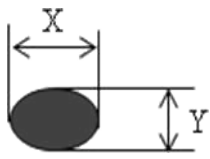
10.4. Standard of appearance test for I area: (unit: mm)

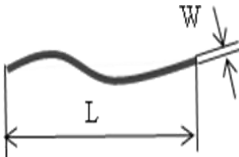
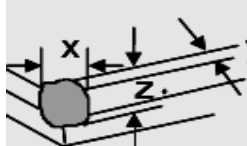
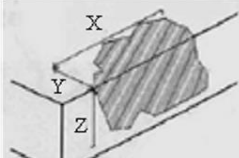
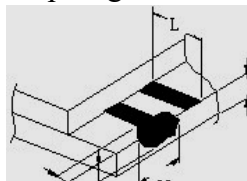
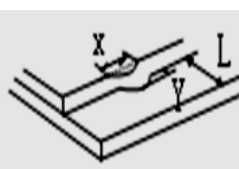
NOTE: Defect ignore for II area .

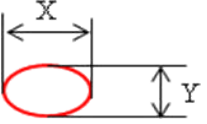
10.4.1 Bright/Dark Dots explain

Name	Explain	Definition
Bright dot	<p>Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern</p> 	<p>The definition of dot: The size of a defective dot over 1/2 of single pixel dot is regarded as one defective dot . NOTE: One pixel consists of 3 sub-pixels, including R,G, and B dot.(Sub-pixel = Dot)</p>
Dark dot	<p>Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.</p> 	
ADJACENT DOT	<p>Adjacent two sub-pixel are defect (define two dot defect)</p>	

10.4.2 Inspection standard

No	Items	Criterion		Checking Manner	Defect Classes
1	Bright/dark dot	Under 6" (contain 6")	<p>Bright dot: 2 Dark dot: N≤4 Note: be more than 5mm apart</p>	Checking with eyes	MAJ
		6"-12"	<p>Bright dot: N≤4 Dark dot: N≤5 Total Bright and Dark Dots: N≤8 Note : 1. Two bright dot defects (red, green, blue, and white) should be larger than 15mm; 2. The distance between black dot defects or black and bright dot defects should be more than 5mm apart.</p>		
2	<p>Spot Defect (Including black spot.white spot. Pinhole.foreign particle.bubbles.hurt)</p>  <p>D=(X+Y)/2</p>	Under 6" (contain 6")	<p>D≤0.1 Ignore 0.1 <D≤0.35 N≤3 0.35<D N=0</p>	Checking with eyes	MIN
		6"-12"	<p>D≤0.3 Ignore 0.3 <D≤0.6 N≤4 0.6<D N=0</p>		

№	Items	Criterion		Checking manner	Defect classes
3	Line Defect (Including black Line.white line. scratch) 	Under 6" (contain 6")	$W \leq 0.02$ Ignore $0.02 <$ $W \leq 0.04$ $L \leq 5 N \leq 2$ $0.04 < W \leq 0.06$ $L \leq 5$ $N \leq 1$ $W > 0.06$ $N = 0$	Checking with eyes	MIN
		6"-12"	$W \leq 0.07$ Ignore $0.07 <$ $W \leq 0.1$ $L \leq 10 N \leq 4$ $W >$ 0.1 $N = 0$		
4	Display abnormal	Not allowed		Checking with eyes	MAJ
5	Outside dimension	Accord with drawing		Callipers	MAJ
6	Class crack	Not allowed		Checking with eyes	MAJ
7	Leak	Not allowed		Checking with eyes	MAJ
8	Comer fragment 	$X \leq 3$ $Y \leq 3$ $Z \leq T$ Ignore Note : 1.No hurt identifying .wire.seal 2.T: Glass thickness X: Length Y: Width Z: thickness		Checking with eyes	MIN
	Side fragment 	$Y \leq 1$ $Z \leq T$ Ignore Note : 1.No hurt identifying .wire.seal 2.T: Glass thickness X: Length Y: Width Z: thickness		Checking with eyes	MIN
9	Step fragment 	$Y \leq 1$ and $Y \leq 1/4 L$		Checking with eyes	MIN
	Incision defect 	$Y \leq 1$ and accord with outside dimension		Checking with eyes	MIN

№	Items	Criterion		Checking manner	Defect classes
10	Newton's ring (CTP or Cover board)  $D = (X + Y) / 2$	Under 6" (contain 6")	$D \leq 25 \quad N \leq 3$ $D > 25 \quad N = 0$	Checking with eyes	MIN
		6"-12"	$D \leq 70 \quad N \leq 5$ $D > 70 \quad N = 0$		

11. Precautions for Use of LCD Modules

11.1 Handling Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol
- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer.

Especially, do not use the following.

- Water
- Ketone
- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary

CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

11.2 Storage Precautions

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

11.3 Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images

and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

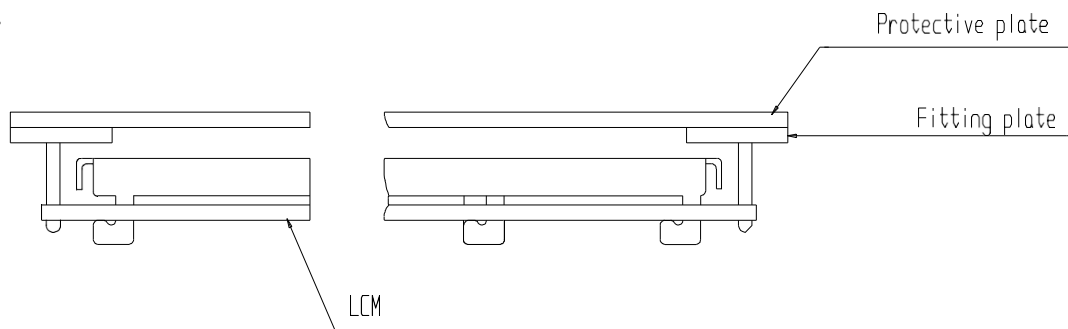
- Exposed area of the printed circuit board.
- Terminal electrode sections.

11.4 USING LCDMODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

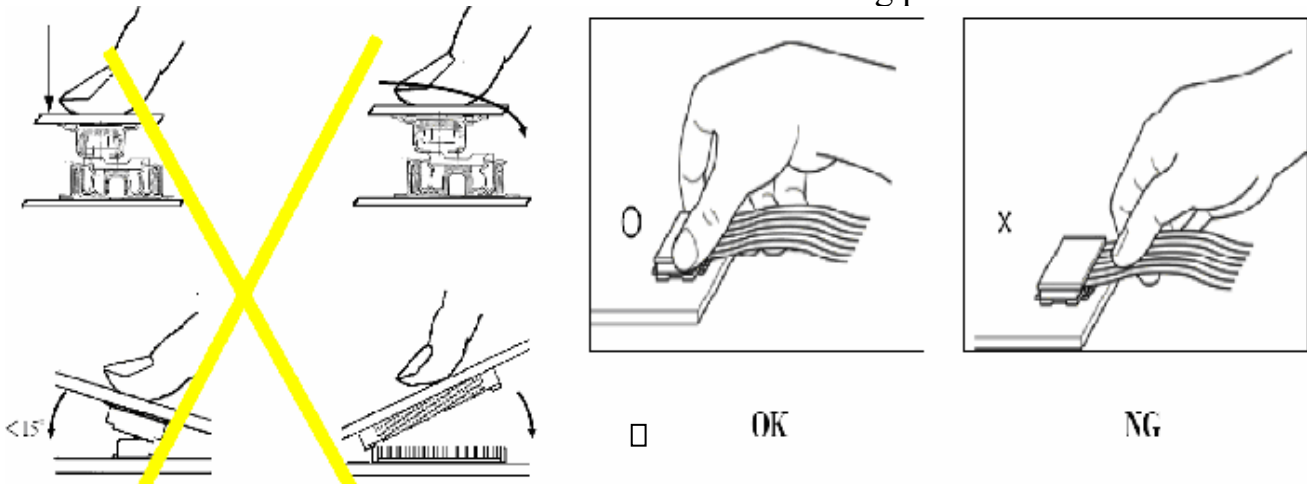
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be $\pm 0.1\text{mm}$.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



Precaution for soldering to the LCM

	Hand soldering	Machine drag	Machine press soldering
No ROHS Product	290°C~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8mm/s.	300°C~330C. Time : 3-6S. Press: 0.8~1.2Mpa
ROHS Product	340°C~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C~360C. Time : 3-6S. Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

(1) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

(2) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(3) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(4) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.

(5) Input each signal after the positive/negative voltage becomes stable.

(6) Please keep the temperature within specified range for use and storage.

Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

12. Prior Consult Matter

1. ① For standard products, we keep the right to change material, process ... for improving the product property without notice on our customer.

② For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.

2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

13. Factory

FACTORY NAME: LCD Mikroelektronik GmbH

FACTORY ADDRESS: Otto-Lilienthal-Str. 13, D-76275 Ettlingen